



Part Number : [956232881](#)

Product Description : Modular Jack, Top Entry, Through Hole, 8/8, Shielded, Tray

Series Number : 95623

Status : Active

Product Category : Modular Jacks and Plugs



Documents & Resources

Drawings

[Drawing 956232881_sd.pdf](#)

[Packaging Design Drawing PK-95123-001.pdf](#)

3D Models and Design Files

[3D Model 956232881_stp.zip](#)


Specifications

[Application Specification AS-85513-001-001.pdf](#)

[Product Specification PS-95623-001-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2023)8585-DC (23 Jan 2024)
EU RoHS	Compliant per EU 2015/863

[Multiple Part Product Compliance Statements](#)

- Eu RoHS
- REACH SVHC
- Low-Halogen

[Multiple Part Industry Compliance Documents](#)

- IPC 1752A Class C

- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	Modular Jacks and Plugs
Series	95623
Description	Modular Jack, Top Entry, Through Hole, 8/8, Shielded, Tray
Comments	Reflow Capable, External Shield
Component Type	PCB Jack
Magnetic	No
Performance Category	3
Power over Ethernet (PoE)	N/A
Product Family	Magnetic and Modular Jacks/Plugs
Product Name	Modular Jack 8/8,RJ45
UPC	800756696676

Agency

UL	E107635
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Electrical

Current - Maximum per Contact	1.5A
Grounding to PCB	Yes
Shielded	Yes
Voltage - Maximum	125V DC

Physical

Boot Color	N/A
Color - Resin	Black
Durability (mating cycles max)	2500

Flammability	94V-0
Inverted / Top Latch	No
Jack Height	16.50mm
Lightpipes/LEDs	None
Material - Metal	Copper Alloy
Material - Plating Mating	Gold over Palladium Nickel
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	6.300/g
Orientation	Vertical (Top Entry)
Packaging Type	Tray
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.57mm
Pitch - Mating Interface	1.02mm
Pitch - Termination Interface	1.27mm
Plating min - Mating	0.051µm, 1.016µm
Plating min - Termination	1.905µm
Port Configuration	1x1
Positions / Loaded Contacts	8/8
Temperature Range - Operating	-40° to +85°C
Termination Interface Style	Through Hole
Waterproof / Dustproof	No
Wire/Cable Type	N/A

Solder Process Data

Max-Duration	45
Lead-Free Process Capability	WAVE
Max-Cycle	3
Max-Temp	260

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